

[I~24] [초청]

## CHARACTERIZATION OF TIN OXIDE FILMS PREPARED BY ION BEAM ASSISTED DEPOSITION (IBAD)

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Undoped tin oxide films were grown on Si substrates by a reactive ion-assisted deposition technique in which oxygen ions were irradiated on depositing Sn particles. In order to investigate the oxidation from SnO to SnO<sub>2</sub>, the effects of initial oxygen contents and heat treatment on the final crystalline structure of tin oxide films were thoroughly examined. Oxygen to Sn metal ratio ( $N_{\text{O}}/N_{\text{Sn}}$ ) of as-deposited films were controlled from 1.1 to 1.9 by varying the relative arrival ratio ( $\Gamma$ ) of oxygen ion to Sn particle from 0.025 to 0.1. Heat treatment was carried out in two different ways; one was post vacuum-annealing at 400 ~ 600°C and the other was *in-situ* annealing 400 ~ 500°C. Crystalline structure of as-deposited tin oxide films at room temperature was amorphous. After post-annealing at 400 °C, only SnO phase was found below  $N_{\text{O}}/N_{\text{Sn}}=1.6$  in x-ray diffraction and crystalline structure of the films comprising higher oxygen contents still appeared to be amorphous. Even though the films still showed SnO phase until  $\Gamma 50$  after 500°C post-annealing, however, mixed structures of SnO, SnO<sub>2</sub>, and intermediate Sn<sub>2</sub>O<sub>3</sub>/Sn<sub>3</sub>O<sub>4</sub> were observed for the films  $\Gamma 75$  and  $\Gamma 100$  with higher oxygen contents. At 600°C annealing, perfect SnO<sub>2</sub> phase was attained for the films having  $N_{\text{O}}/N_{\text{Sn}}=1.9$ . On the other hand, pure polycrystalline SnO<sub>2</sub> films could be obtained by *in-situ* annealing at low temperature. The values of  $N_{\text{O}}/N_{\text{Sn}}$  and the chemical shifts with the variation of oxidation were carefully determined by the comparison of Sn *MNN* and O *KLL* Auger transitions. In particular, the AES *M<sub>5</sub>N<sub>4,5</sub>N<sub>4,5</sub>* Auger transition peak intensity was reduced as oxidation state increased. Surface microstructure of deposited films was also analyzed using a scanning electron microscopy (SEM) and an atomic force microscope (AFM) in terms of average depositing ion energy.